

1746

To: Technology Center 1700
Facsimile Number: 703-872-9306

Total Pages Sent 9

From: Jacqueline J. Garner
Texas Instruments Incorporated
Facsimile: 972-917-4418
Phone: 214-532-9348

RECEIVED
CENTRAL FAX CENTER

JUN 21 2004

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

OFFICIAL

Applicant: Tsuga et al.

Art Unit: 1746

Serial No.: 10/085,725

Examiner: Kornakov, M.

Filing Date: 02/28/2002

Docket No.: TI-31621

Customer No.: 23494

Conf. No.: 1672

Title: METHOD AND DEVICE FOR REMOVING PARTICLES ON
SEMICONDUCTOR WAFERS

CERTIFICATION OF FACSIMILE TRANSMISSION

I hereby certify that the following papers are being transmitted by
facsimile to the U.S. Patent and Trademark Office at 703-872-
9306 on the date shown below:

Jacqueline J. Garner, Reg. No. 36,144

June 21, 2004
Date

FACSIMILE COVER SHEET

<input checked="" type="checkbox"/> FACSIMILE COVER SHEET	<input checked="" type="checkbox"/> AMENDMENT (5 Pages)
<input type="checkbox"/> NEW APPLICATION	<input checked="" type="checkbox"/> EOT 2mth (3 Pages)
<input type="checkbox"/> DECLARATION (# Pages)	<input type="checkbox"/> NOTICE OF APPEAL (# Pages)
<input type="checkbox"/> ASSIGNMENT (# Pages)	<input type="checkbox"/> APPEAL (# Pages)
<input type="checkbox"/> FORMAL DRAWINGS	<input type="checkbox"/> ISSUE FEE (# Pages)
<input type="checkbox"/> INFORMAL DRAWINGS	<input type="checkbox"/> REPLY BRIEF (IN TRIPLICATE) (# Pages)
<input type="checkbox"/> CONTINUATION APP'N (# Pages)	
<input type="checkbox"/> DIVISIONAL APP'N	
NAME OF INVENTOR(S): Tsuga et al	
TITLE OF INVENTION: Method and Device for Removing . . .	
TI FILE NO.: TI-31621	DEPOSIT ACCT. NO.: 20-0668
FAXED: 6/21/2004 DUE: 4/20/2004 ATTY/SEC'Y: JJG	
RECEIPT DATE & SERIAL NO.: Serial No.: 10/085,725 Filing Date: 02/28/2002 Conf. No.: 1672	

This facsimile is intended only for the use of the address named and contains legally privileged and/or confidential information. If you are not the intended recipient of this telecopy, you are hereby notified that any dissemination, distribution, copying or use of this communication is strictly prohibited. Applicable privileges are not waived by virtue of the document having been transmitted by Facsimile. Any misdirected facsimiles should be returned to the sender by mail at the address indicated on this cover sheet.

Texas Instruments Incorporated
PO Box 655474, M/S 3999
Dallas, TX 75074